

## Power Choke Coil HTEX20161T MDR type

### ■ Features

High performance (Isat) realized by metal dust core.

Low profile : 2.0 mm x 1.6 mm x 1.0 mm

Low loss realized with low DCR

100% lead (Pb) free meet RoHS standard

### ■ Application

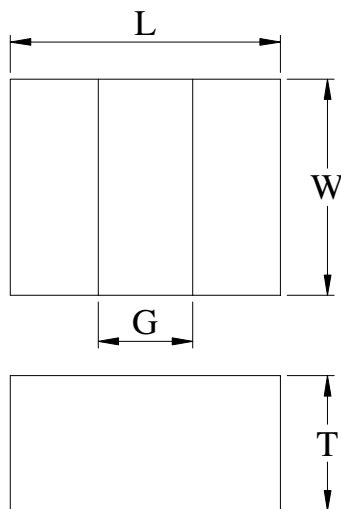
DC/DC converter for CPU in Notebook PC

Cellular phones, LCD displays, HDDs, DVCs, DSCs, PDAs etc..

Thin type on-board power supply module for exchanger

VRM for server

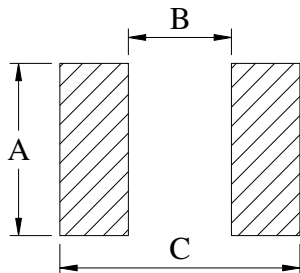
### ■ Outline Dimensions



Code	Dimensions(mm)
L	$2.0 \pm 0.1$
W	$1.6 \pm 0.1$
T	1.0 Max.
G	0.6 Typ.

### ■ Recommend Land Pattern Dimensions

The customer shall determine the land dimensions shown below after confirming and safety.



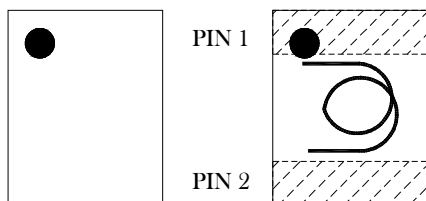
A	1.6
B	0.5
C	2.0

Unit : mm

### ■ Marking

The point on the top surface represents winding direction of choke.

Upside of Chip



Coil clockwise around

### ■ Specifications

Part Number	L0 Inductance ( $\mu\text{H}$ ) @ (0A)	R <sub>dc</sub> (m $\Omega$ )		Heat Rating Current DC Amps. Idc (A)		Saturation Current DC Amps. Isat (A)	
		Typical	Maximum	Typical	Maximum	Typical	Maximum
HTEX20161T-4R7MDR	4.7	210	250	1.5	1.3	1.9	1.7

\* : If you require another part number please contact with us.

\*\* : Inductance Tolerance  $\pm 20\%$

Note 1. : All test data is referenced to 25°C ambient.

Note 2. : Test Condition: 1MHz, 1.0Vrms

Note 3. : Idc : DC current (A) that will cause an approximate  $\Delta T$  of 40°C

Note 4. : Isat : DC current (A) that will cause L0 to drop approximately 30%

Note 5. : Operating Temperature Range -55°C to + 125°C

Note 6. : The part temperature (ambient + temp rise) should not exceed 125°C under the worst case operating conditions. Circuit design , component placement, PCB trace size and thickness, airflow and other cooling provision all affect the part temperature. Part temperature should be verified in the end application.

Note 7. : The rated current as listed is either the saturation current or the heating current depending on which value is lower.

■ Current Characteristic

